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As a below named inventor, I h	•			
My residence, post office and c	tizenship are as stated below	renext to my name,		
I believe I am the original, firs inventor (if plural names are li- invention entitled <u>DRIVING</u> CO	sted below) of the subject in	matter claimed and for	which a patent.	is sought on the
[X] is attached hereto	AND METHOD THEREOF was filed on	as Application Ser	rial No.	and was
amended on		(if applicable)		
I hereby state that I have revier claims, as amended by any ame	wed and understand the condition in the condition of the	itents of the above ident	tified specificati	on, including the
I acknowledge the duty to disc with Title 37, Code of Federal I	ose information which is ki legulations, Section 1.56(a).	lown to me to be mater	ial to patentabil	ity in accordance
I hereby claim foreign priority to or inventor's certificate, or 365( than the United States of Amer application for patent or invent that of the application on which	a) of any PCT international ca, listed below and have alsor's certificate, or of any PC	application which design to identified below, by ch	ated at least one hecking the box	e country other , any foreign
Prior Foreign Application(s): Number	Coun	ù <b>y</b> .	Foreign Fili Month/Da	
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I hereby claim the benefit unde	35 U.S.C. 119(e) of any Un	ited States provisional ap	pplication(s) list	ed below.
Application Number(s):	Į.	iling Date (Month/D	ay/Year)	
I hereby claim the benefit us international application design each of the claims of this appli the manner provided by the fire is material to patentability as d application and the national or	ating the United States of A cation is not disclosed in the comparagraph of 35 U.S.G. 11 efined in 37 CFR 1.56 while	merica, listed below and prior United States or 2, Tacknowledge the du th became available bety	l, insofar as the PCT internation ity to disclose in	subject matter of nal application in formation which
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74-73-7				<u> </u>

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

I hereby appoint the following attorney(s) and/or agent(s) associated with Customer Number 34610 with full power of substitution and revocation, to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. <u>Direct all correspondence to Customer Number 34610</u>.

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